

SPECIFICATIONS

Rated Current:3.0AMP
 Contact Resistance:20mΩ Max
 Withstand Voltage:1000V AC/DC
 Insulation Resistance:1000MΩ Min
 Operation Temperature:-40°c to +105°c

Contact Material:Brass
 Contact Plating:Au or Sn Over Ni
 Insulator Material:Polyester(UL94V-0)
 Resistance To Soldering Heat:
 245° C ±5° C, 10s(PBT insulator)
 260° C ±5° C, 10s(PA6T&PA9T&LCP insulator)

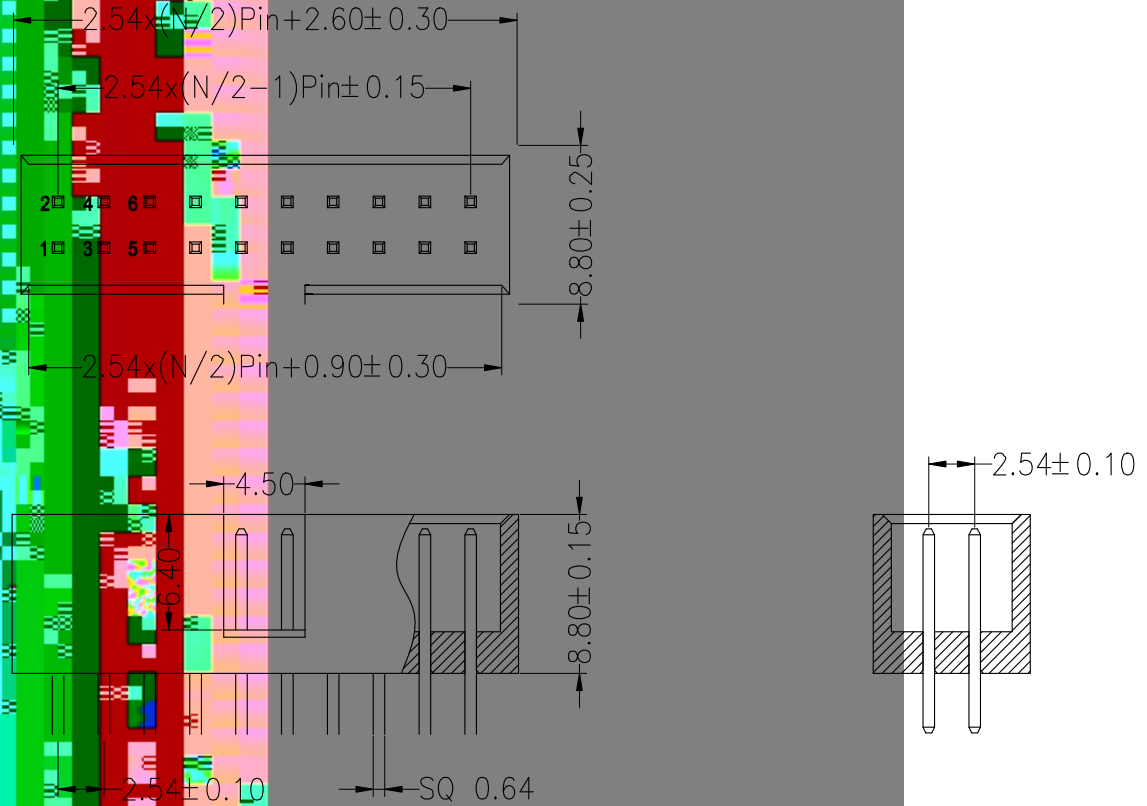
Ordering Information

3213 XX S XX X B K00 X 0X

Contact Plating
 G0:Gold Flash
 G1:1u" Gold
 G2:1.5u" Gold
 G3:2u" Gold
 G4:3u" Gold
 G5:5u" Gold
 G6:10u" Gold
 G7:15u" Gold
 G8:30u" Gold
 S0:Gold Flash/Tin
 SN:Tin

Insulator Material
 Option
 C=BK-PA6T
 E=T

Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



			OPERATION	DRAW	Jelly Feng	22.07.01	SCALE	FIT		
			X.X	±0.30			UNIT	mm		
			X.XX	±0.20	CHECK		SIZE	A4	PART NO.	3213XXSXXXBK00X0X
A0	2022.07.01	NEW DRAWING	X.XXX	±0.10			SHEET	1/1	TITLE:	2.54mm Box Header H8.8mm 180° 短体
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	DIM	TOL	APPROVE	PROJ.	☉		
1	2	3	4	5	6	7	8	9		